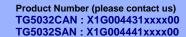


TCXO / VC-TCXO **ULTRA HIGH STABILITY**









Feature

• Frequency range : 10 MHz to 40 MHz

: 3.3 V Supply voltage

TG5032CAN

TG5032SAN

• Frequency / temperature characteristics

: ±0.1 x 10⁻⁶ Max. *1

• External dimensions : 5.0 × 3.2 × 1.45 mm (10-pins)

 Applications : FemtoCell Features : Ultra high stability

Actual size



Specifications (characteristics)

Openications (characteristics)						
Item	Symbol	TG5032CAN (CMOS)		TG5032SAN (Clipped sine wave)		Conditions / Remarks
		VC-TCXO	TCXO	VC-TCXO	TCXO	Conditions / Remarks
Output frequency range	fo	10 MHz to 40 MHz				
		19.2, 20, 26, 30.72 MHz			Standard frequency	
Supply voltage	V_{cc}	3.3 V± 0.165V (Supply voltage range :2.7 V to 5.5 V)				
Storage temperature	T_stg	-40 °C to +90 °C			Storage as single product	
Operating temperature	T_use	0 °C to +70 °C				
Frequency tolerance	f_tol	±2.0 × 10 ⁻⁶ Max.				After reflow, +25 °C
Frequency/temperature characteristics*1	fo-Tc	±0.1 ×10 ⁻⁶ Max.				0 °C to +70 °C
Frequency/load coefficient	fo-Load	±0.1 ×10 ⁻⁶ Max.				Load ±10 %
Frequency/voltage coefficient	fo-Vcc	±0.1 ×10 ⁻⁶ Max.				Vcc=3.3 V ± 0.165 V
Frequency aging*2	f_age	±0.02 ×10 ⁻⁶ Max.			+25 °C, 24h	
		±1.0 ×10 ⁻⁶ Max.			+25 °C, First year	
Current consumption	Icc	5.0 mA Max.		5.0 mA Max.		10 MHz≦ fo ≦26 MHz
		6.0 mA Max.		5.0 MA	Max.	26 MHz < fo ≦40 MHz
Input resistance	Rin	100 kΩ Min.	_	100 kΩ Min.	_	Vc- GND (DC)
Frequency control range	f_cont	±5 ×10 ⁻⁶ to		±5 ×10 ⁻⁶ to ±10 ×10 ⁻⁶		Vc=1.5 V ± 1.0 V
		±10 ×10 ⁻⁶	_		_	
Frequency change polarity		Positive polarity	_	Positive polarity	_	
Symmetry	SYM	45 % to 55 %				GND level (DC cut)
Output voltage	Vон	90 % Vcc Min.		_		
	Vol	10 % Vcc Max.		_		
Output level	VPP	_		0.8 V Min.		Peak to Peak
Output load condition	Load	15 pF Max.		10 kΩ//10 pF		

* Note: Please contact us for requirements not listed in this specification. *1 Based on frequency at (fmax+fmin)/2. *2 After 48 hours operating

Product Name (Standard form) TG5032 C AN 19.200000MHz C A A N A A 1 0 (3) 4 5 6 7 8 9

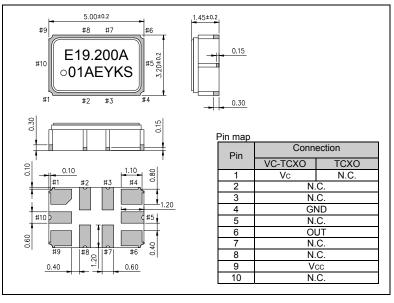
①Model ②Output (C: CMOS, S: Clipped sine wave) ③Frequency ④Supply voltage (C: 3.3 V Typ.) ⑤Frequency / temperature characteristics (A: $\pm 0.1 \times 10^{-6} \text{ Max.}$) ⑥Operating temperature (A: 0 °C to +70 °C)

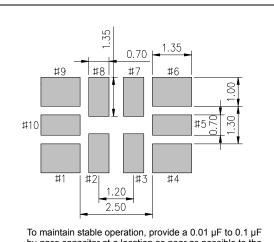
(Standby function (N: Non) (SVc function(A: VC-TCXO, N: Non) Internal identification code ("A" is default)

External dimensions

(Unit:mm)

Footprint (Recommended) (Unit :mm)





by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{CC} - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs,

Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



- ► Complies with EU RoHS directive.
 - *About the products without the Pb-free mark.

 Contains Pb in products exempted by EU RoHS directive.

 (Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



 \blacktriangleright Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

Notice

- This material is subject to change without notice.
- Any part of this material may not be reproduced or duplicated in any form or any means without the written permission of Seiko Epson.
- The information about applied circuitry, software, usage, etc. written in this material is intended for reference only. Seiko Epson does
 not assume any liability for the occurrence of infringing on any patent or copyright of a third party. This material does not authorize the
 licensing for any patent or intellectual copyrights.
- When exporting the products or technology described in this material, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
- You are requested not to use the products (and any technical information furnished, if any) for the development and/or manufacture of
 weapon of mass destruction or for other military purposes. You are also requested that you would not make the products available to
 any third party who may use the products for such prohibited purposes.
- These products are intended for general use in electronic equipment. When using them in specific applications that require extremely high reliability, such as the applications stated below, you must obtain permission from Seiko Epson in advance.
 - / Space equipment (artificial satellites, rockets, etc.) / Transportation vehicles and related (automobiles, aircraft, trains, vessels, etc.) / Medical instruments to sustain life / Submarine transmitters / Power stations and related / Fire work equipment and security equipment / traffic control equipment / and others requiring equivalent reliability.
- · All brands or product names mentioned herein are trademarks and/or registered trademarks of their respective.